Advance Information

512K x 32 Bit Fast Static RAM Module

The MCM32515 is a 16M bit static random access memory module organized as 524,288 words of 32 bits. The module is offered in a 72–lead single in–line memory module (SIMM). Four MCM6246 fast static RAMs, packaged in 36–lead SOJ packages are mounted on a printed circuit board along with eight decoupling capacitors.

The MCM6246 is a high–performance CMOS fast static RAM organized as 524,288 words of 8 bits. Static design eliminates the need for external clocks or timing strobes, while CMOS circuitry reduces power consumption and provides for greater reliability.

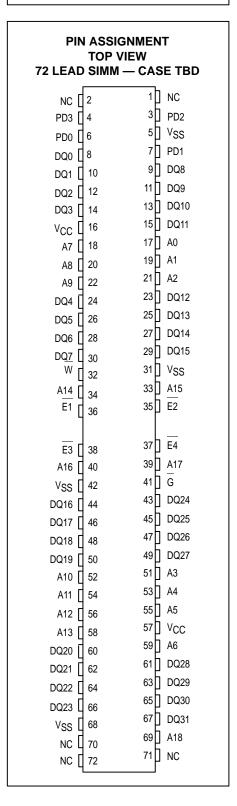
The MCM32515 is equipped with output enable (G) and four separate byte enable (E1 - E4) inputs, allowing for greater system flexibility. The G input, when high, will force the outputs to high impedance. Ex high will do the same for byte x.

- Single 5 V ± 10% Power Supply
- Fast Access Times: 20/25 ns
- Three-State Outputs
- · Fully TTL Compatible
- JEDEC Standard Pinout
- Power Requirement: 800/740 mA Maximum, Active AC
- High Board Density SIMM Package
- Byte Operation: Four Separate Chip Enables, One for Each Byte
- High Quality Six-Layer FR4 PWB with Separate Internal Power and Ground Planes
- Incorporates Motorola's State-of-the-Art Fast Static RAMs

PIN NAMES									
<u>A0</u> – A18 Address Inputs									
<u>W</u> Write Enable									
<u>G</u> Output Enable									
E1 – E4 Byte Enables									
DQ0 – DQ31 Data Input/Output									
V _{CC} + 5 V Power Supply									
V _{SS} Ground									
PD0 – PD3 Package Density									
NC No Connect									

For proper operation of the device, VSS must be connected to ground.

MCM32515



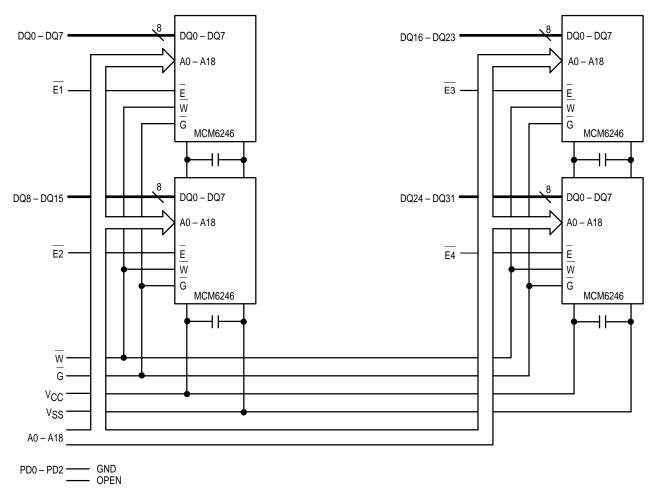
This document contains information on a new product. Specifications and information herein are subject to change without notice.

REV 2 4/7/97



FUNCTIONAL BLOCK DIAGRAM

512K x 32 MEMORY MODULE



MCM32515

TRUTH TABLE

Ex	G	W	Mode	V _{CC} Current	Output	Cycle
Н	Х	Х	Not Selected	I _{SB1} or I _{SB2} High–Z		_
L	Н	Н	Read	ICCA	High–Z	_
L	L	Н	Read	ICCA	D _{out}	Read Cycle
L	Х	L	Write	ICCA	D _{in}	Write Cycle

ABSOLUTE MAXIMUM RATINGS (Voltages referenced to $V_{SS} = 0 \text{ V}$)

Rating	Symbol	Value	Unit
Power Supply Voltage	Vcc	- 0.5 to 7.0	V
Voltage Relative to V _{SS}	V _{in} , V _{out}	-0.5 to $V_{CC} + 0.5$	V
Output Current (per I/O)	l _{out}	± 30	mA
Power Dissipation	PD	4.0	W
Temperature Under Bias	T _{bias}	– 10 to + 85	°C
Operating Temperature	TA	0 to + 70	°C
Storage Temperatrue	T _{stg}	– 25 to + 125	°C

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPERATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

The devices on this module contain circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to these high imped-

These CMOS memory circuits have been designed to meet the dc and ac specifications shown in the tables, after thermal equilibrium has been established. The module is in a test socket or mounted on a printed circuit board and transverse air flow of at least 500 linear feet per minute is maintained.

DC OPERATING CONDITIONS AND CHARACTERISTICS

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, T_A = 0 \text{ to} + 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$

RECOMMENDED OPERATING CONDITIONS (Voltages referenced to V_{SS} = 0 V)

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage (Operating Voltage Range)	Vcc	4.5	5.0	5.5	V
Input High Voltage	ViH	2.2		V _{CC} +0.3*	V
Input Low Voltage	V _{IL}	- 0.5**		0.8	V

 $^{^*}$ V_{IH} (max) = V_{CC} + 0.3 V dc; V_{IH} (max) = V_{CC} + 2 V ac (pulse width \le 20 ns) ** V_{IL} (min) = - 3.0 V ac (pulse width \le 20 ns)

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Input Leakage Current (All Inputs, V _{in} = 0 to V _{CC})	l _{lkg(l)}	_	_	± 4	μΑ
Output Leakage Current (G, Ex = V _{IH} , V _{Out} = 0 to V _{CC})	l _{lkg(O)}	_	_	± 4	μΑ
AC Active Supply Current (G, Ex = V_{IL} , I_{Out} = 0 mA, MCM32515–20: t_{AVAV} = 20 ns Cycle time $\geq t_{AVAV}$ min) MCM32515–25: t_{AVAV} = 25 ns	ICCA	_	760 700	800 740	mA
AC Standby Current (Ex = V _{IH} , Cycle time ≥ t _{AVAV} min)	I _{SB1}	_	220	240	mA
CMOS Standby Current (Ex \geq V _{CC} $-$ 0.2 V, All Inputs \geq V _{CC} $-$ 0.2 V or \leq 0.2 V)	I _{SB2}	_	40	60	mA
Output Low Voltage (I _{OL} = + 8.0 mA)	VOL	_	_	0.4	V
Output High Voltage (I _{OH} = – 4.0 mA)	Voн	2.4	_	_	V

NOTE: Good decoupling of the local power supply should always be used.

CAPACITANCE (f = 1.0 MHz, dV = 3.0 V, TA = 25°C, Periodically Sampled Rather Than 100% Tested)

Characteristic		Symbol	Тур	Max	Unit
Input Capacitance	(All pins except DQ0 – DQ31, W, G, and $\underline{E1}$ – $\underline{E4}$) (E1 – $\underline{E4}$) (W, G)	C _{in}	16 10 20	24 14 32	pF
Input/Output Capacitance	(DQ0 – DQ31)	C _{out}	8	9	pF

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AC OPERATING CONDITIONS AND CHARACTERISTICS

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, T_A = 0 \text{ to} + 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$

Input Timing Measurement Reference Level 1.5 V	V	Output Load See Figure 1a Unless Otherwise Noted
Output Timing Reference Level	V	Input Rise/Fall Time
Input Pulse Levels 0 to 3.0 V	V	

READ CYCLE TIMING (See Notes 1 and 2)

		MCM32515-20		MCM32	515–25		
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Read Cycle Time	t _{AVAV}	20	_	25	_	ns	3
Address Access Time	t _{AVQV}	_	20	_	25	ns	
Enable Access Time	^t ELQV	_	20	_	25	ns	
Output Enable Access Time	tGLQV	_	7	_	9	ns	
Output Hold from Address Change	tAXQX	5	_	5	_	ns	
Enable Low to Output Active	^t ELQX	5	_	5	_	ns	4,5,6
Output Enable to Output Active	^t GLQX	0	_	0	_	ns	4,5,6
Enable High to Output High–Z	^t EHQZ	0	9	0	10	ns	4,5,6
Output Enable High to Output High–Z	^t GHQZ	0	9	0	10	ns	4,5,6
Power Up Time	^t ELICCH	0	_	0	_	ns	
Power Down Time	^t EHICCL	_	20	_	25	ns	

NOTES:

- 1. W is high for read cycle.
- 2. E1 E4 are represented by E in these timing specifications, any combination of Exs may be asserted.
- 3. All read cycle timing is referenced from the last valid address to the first transitioning address.
- 4. At any given voltage and temperature, tEHQZ max is less than tELQX min, and tGHQZ max is less than tGHQX min, both for a given device and from device to device.
- 5. Transition is measured \pm 500 mV from steady–state voltage with load of Figure 1b.
- 6. This parameter is sampled and not 100% tested.
- 7. Device is continuously selected (E = V_{IL}, G = V_{IL}).

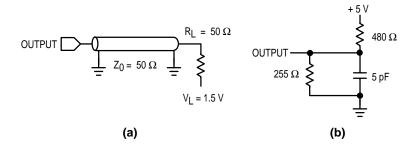


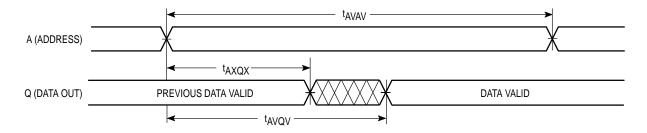
Figure 1. Test Loads

TIMING LIMITS

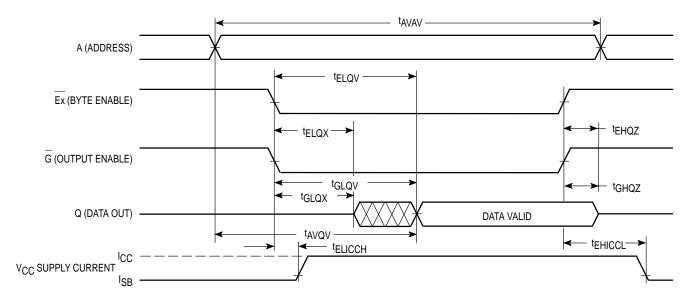
The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time. On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.

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READ CYCLE 1 (See Note 7 Above)



READ CYCLE 2 (See Note)



NOTE: Addresses valid prior to or coincident with E going low.

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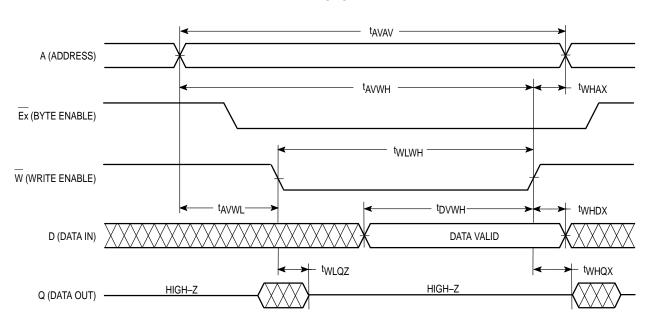
WRITE CYCLE 1 (W Controlled, See Notes 1 and 2)

		MCM32515-20		MCM32	515–25		
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	t _{AVAV}	20	_	25	_	ns	3
Address Setup Time	tAVWL	0	_	0	_	ns	
Address Valid to End of Write	tAVWH	15	_	17	_	ns	
Write Pulse Width	^t WLWH, ^t WLEH	15	_	17	_	ns	
Data Valid to End of Write	^t DVWH	10	_	10	_	ns	
Data Hold Time	tWHDX	0	_	0		ns	
Write Low to Data High–Z	tWLQZ	0	9	0	10	ns	4,5,6
Write High to Output Active	tWHQX	5		5		ns	4,5,6
Write Recovery Time	tWHAX	0	_	0		ns	

NOTES:

- 1. A write occurs during the overlap of E low and W low.
- 2. $\overline{E1} \overline{E4}$ are represented by \overline{E} in these timing specifications, any combination of \overline{Ex} may be asserted. \overline{G} is a don't care when \overline{W} is low.
- 3. All write cycle timing is referenced from the last valid address to the first transitioning address.
- 4. Transition is measured \pm 500 mV from steady–state voltage with load of Figure 1b.
- 5. This parameter is sampled and not 100% tested.
- 6. At any given voltage and temperature, t_{WLQZ} max is less than t_{WHQX} min both for a given device and from device to device.

WRITE CYCLE 1



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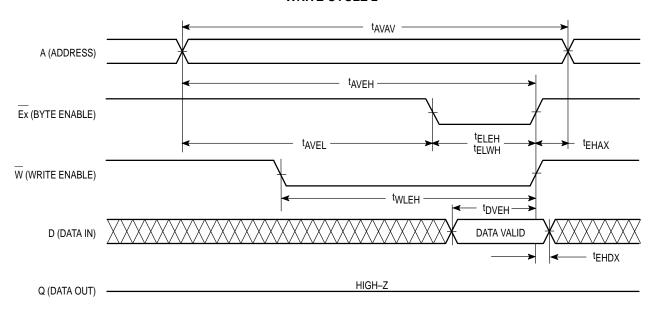
WRITE CYCLE 2 (E Controlled, See Notes 1 and 2)

		MCM32515-20		MCM32515-25			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	tAVAV	20	_	25	_	ns	3
Address Setup Time	^t AVEL	0	_	0	_	ns	
Address Valid to End of Write	^t AVEH	15	_	17	_	ns	
Enable to End of Write	^t ELEH	15	_	17	_	ns	4,5
Enable to End of Write	^t ELWH	15	_	17	_	ns	
Write Pulse Width	tWLEH	15	_	17	_	ns	
Data Valid to End of Write	^t DVEH	10	_	10	_	ns	
Data Hold Time	^t EHDX	0	_	0		ns	
Write Recovery Time	^t EHAX	0		0		ns	

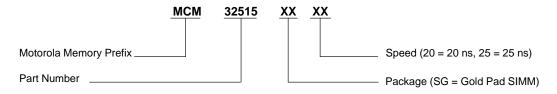
NOTES:

- 1. A write occurs during the overlap of E low and W low.
- 2. $\overline{E1}$ $\overline{E4}$ are represented by \overline{E} in these timing specifications, any combination of \overline{Ex} s may be asserted. \overline{G} is a don't care when \overline{W} is low.
- 3. All_write cycle timing is referenced from the last valid address to the first transitioning address.
- 4. If E goes low coincident with or after W goes low, the output will remain in a high impedance condition.
- 5. If E goes high coincident with or before W goes high, the output will remain in a high impedance condition.

WRITE CYCLE 2



ORDERING INFORMATION (Order by Full Part Number)



Full Part Numbers — MCM32515SG20 MCM32515SG25

MOTOROLA FAST SRAM MCM32515

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